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DCPL-WB-02D3

Wide-band, dual-path directional coupler with integrated 50 ohm loaded isolated port

Datasheet - production data

Features

- \blacksquare 50 Ω nominal input / output impedance
- Wide operating frequency range:
 - 2400 MHz-5850 MHz
- Low insertion loss
- High ESD ruggedness
- Lead-free CSP
- Small footprint: 1670 x 1440 µm
- Very low profile (< 600 µm after reflow)</p>

Benefits

- High RF performance
- RF module size reduction

Applications

Multi-band equipment such as:

- Power amplifier module
- Front end module
- WLAN

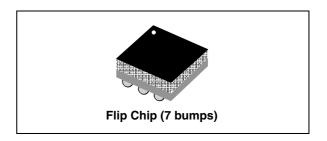
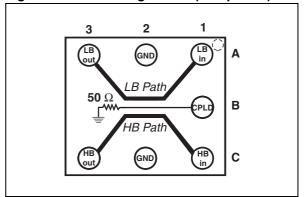


Figure 1. Pin configuration (bump view)



Description

The DCPL-WB-02D3 is a wide-band, dual-path directional coupler designed to measure transmission output power in WLAN applications. This dual path CPL has been customized for wide-band operating frequencies (2G/5G WLAN) with low insertion losses in the transmission bandwidth (2400 MHz - 5850 MHz).

This device is built with two different RF couplers (one dedicated to LB, the other dedicated to HB) sharing the same coupled ports. Isolated port is loaded with an integrated 50 Ω resistor.

The DCPL-WB-02D3 has been designed using STMicroelectronics IPD (integrated passive device) technology on non-conductive glass substrate to optimize RF performance. The device is delivered 100% tested in tape and reel.

Characteristics DCPL-WB-02D3

1 Characteristics

Table 1. Absolute maximum rating (limiting values)

Symbol	Parameter	Value			Unit	
Symbol	Farameter	Min.	Тур.	Max.	Oilit	
P _{IN}	Input Power RF _{IN} (CW mode)			25	dBm	
V _{ESD (HBM)}	Human body model, JESD 22-A114F, all I/O	2			kV	
V _{ESD (MM)}	Machine model, JESD 22-A115-A, all I/O	100			V	
V _{ESD (CDM)}	Charge device model, JESD 22-C101-C, all I/O	500			V	
T _{OP}	Operating temperature	-30		+85	°C	

Table 2. Electrical characteristics - impedances ($T_{amb} = 25$ °C)

Symbol	Parameter		Value			
Symbol	Farameter	Min.	Тур.	Max.	Unit	
Z _{OUT}	Nominal output impedance (LB and HB paths)		50		Ω	
Z _{IN}	Nominal input impedance (LB and HB paths)		50		Ω	
Z _{CPL}	Nominal coupled port impedance		50		Ω	

DCPL-WB-02D3 Characteristics

Table 3. Electrical characteristics - LB WLAN path RF performance ($T_{amb} = 25 \, ^{\circ}C$)

Symbol	Parameter	Test condition	Value			Unit
	T di dinotoi		Min.	Тур.	Max.	
f	Frequency range (bandwidth)		2400	2450	2500	MHz
IL _{LB}	LB path insertion loss	From 2400 MHz to 2500 MHz			0.2	dB
RL _{LB}	LB path return loss (IN, OUT pins)	From 2400 MHz to 2500 MHz	15			dB
CPLD _{LB}	LB path coupling factor	at 2.45 GHz	17	18	19	dB
Ripple _{LB}	Coupling ripple in LB	From 2400 MHz to 2500 MHz			0.5	dB

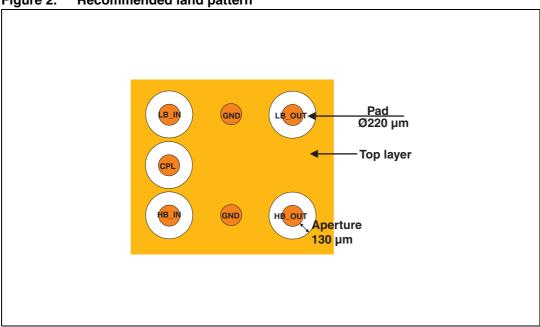
Table 4. Electrical characteristics - HB WLAN path RF performance ($T_{amb} = 25$ °C)

Symbol	Parameter	Test condition	Value			Unit	
Cymbol	r drameter	root containen	Min.	Тур.	Max.	- ***	
f	Frequency range (bandwidth)		4900	5375	5850	MHz	
IL _{HB}	HB path insertion loss	From 4900 MHz to 5850 MHz			0.5	dB	
RL _{HB}	HB path return loss (IN, OUT pins)	From 4900 MHz to 5850 MHz	15			dB	
CPLD _{HB}	HB path coupling factor	at 5.375 GHz	11	12	13	dB	
Ripple _{HB}	Coupling ripple in HB	From 4900 MHz to 5850 MHz			1.2	dB	

PCB recommendation DCPL-WB-02D3

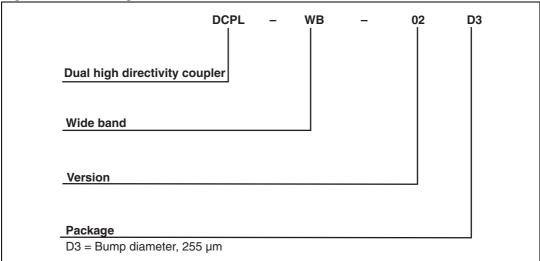
2 PCB recommendation

Figure 2. Recommended land pattern



3 Ordering information scheme

Figure 3. Ordering information scheme



DCPL-WB-02D3 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 4. Package dimensions

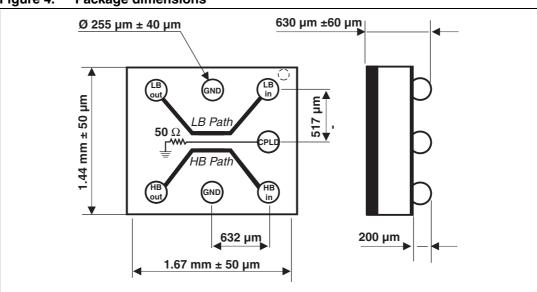


Figure 5. Footprint

Figure 6. Marking

Dot, ST logo
ECOPACK status
xx = marking
z = manufacturing
location
yww = datecode
(y = year
ww = week)

Solder stencil opening:
220 µm recommended

Y

W

W

Package information DCPL-WB-02D3

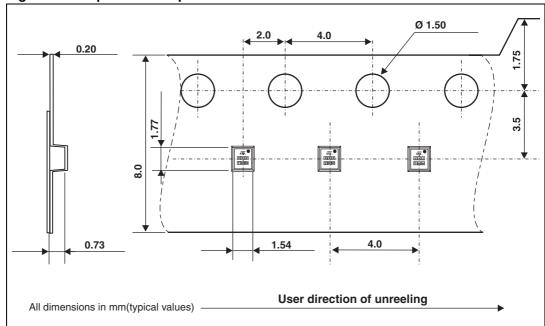


Figure 7. Tape and reel specifications

Note: More packing information is available in the STMicroelectronics Application notes:

AN2348: "IPAD™ 400 µm Flip Chip: package description and recommendations for use"

AN1751: "EMI Filters: recommendations and measurements"

5 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
DCPL-WB-02D3	SF	Flip Chip	2.5 mg	5000	Tape and reel 7"

6 Revision history

Table 6. Document revision history

Date	Revision	Changes
18-Jun-2012	1	Initial release

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